

Form 1449 (Modified)

**Information Disclosure
Statement By Applicant**

(Use Several Sheets if Necessary)

Atty. Docket No.

AND1P400

Applicant:

Cheah Wee Leong et al.

Filing Date:

12/22/99

Application No.:

09/470,042

Group Art. Unit:

36212788

U.S. Patent Documents

Examiner Initial	No.	Patent No.	Date	Patentee	Class	Sub-class	Filing Date
P.R.	A	5,918,218	06/29/99	Harris et al.	705	37	09/01/94
	B	5,905,974	05/18/99	Fraser et al.	705	37	12/13/96
	C	5,905,973	05/18/99	Yonezawa et al.	705	27	09/29/97
	D	5,904,485	05/18/99	Siefert	434	322	11/04/94
	E	5,895,450	04/20/99	Sloo	705	1	07/14/97
	F	5,892,900	04/06/99	Ginter et al.	395	186	08/30/96
	G	5,890,139	03/30/99	Suzuki et al.	705	27	07/16/96
	H	5,890,137	03/30/99	Koreeda	705	26	07/26/96
	I	5,890,136	03/30/99	Kipp	705	22	03/12/97
	J	5,870,746	02/09/99	Knutson et al.	707	101	10/31/96
	K	5,860,862	01/19/99	Junkin	463	40	01/05/96

Foreign Patent or Published Foreign Patent Application

Examiner Initial	No.	Document No.	Publication Date	Country or Patent Office	Class	Sub-class	Translation	
							Yes	No
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Other Documents

Examiner Initial	No.	Author, Title, Date, Place (e.g. Journal) of Publication
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Examiner	Date Considered	

Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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Cheah Wee Leong et al.

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12/22/99

Group Art Unit

3621 2768

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TC 2100 MAIL ROOM**U.S. Patent Documents**

Examiner Initial	No.	Patent No.	Date	Patentee	Class	Sub-class	Filing Date
P.E.	A	5,848,396	12/08/98	Gerace	705	10	04/26/96
	B	5,826,242	10/20/98	Montulli	705	27	08/27/97
	C	5,819,092	10/06/98	Ferguson et al.	395	701	10/06/97
	D	5,809,483	09/15/98	Broka et al.	705	37	11/14/97
	E	5,787,402	07/28/98	Potter et al.	705	37	10/08/96
	F	5,753,656	05/19/98	Sakai et al.	514	249	08/04/95
	G	5,740,549	04/14/98	Reilly et al.	705	14	06/12/95
	H	5,717,989	02/10/98	Tozzoli et al.	705	37	10/13/94
	I	5,710,887	01/20/98	Chelliah et al.	395	226	08/29/95
	J	5,579,222	11/26/96	Bains et al.	395	712	12/14/92
	K	5,023,907	06/11/91	Johnson et al.	380	4	09/30/88

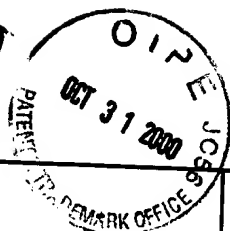
Foreign Patent or Published Foreign Patent Application

Examiner Initial	No.	Document No.	Publication Date	Country or Patent Office	Class	Sub-class	Translation	
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Other Documents

Examiner Initial	No.	Author, Title, Date, Place (e.g. Journal) of Publication
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Examiner	Blanca June S.	
	Date Considered 6/20/02	

Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.



Form 1449 (Modified) Information Disclosure Statement By Applicant (Use Several Sheets if Necessary)	Atty. Docket No. AND1P400	Application No.: 09/470,042
	Applicant: Cheah Wee Leong et al. Filing Date: 12/22/99	Group Art Unit: 2768 3621

U.S. Patent Documents

Examiner Initial	No.	Patent No.	Date	Patentee	Class	Sub-class	Filing Date
<i>P.A.</i>	A	4,937,863	06/26/90	Robert et al.	380	4	03/07/88
<i>P.A.</i>	B	4,677,552	06/30/87	Sibley, Jr.	364	408	10/05/84
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Foreign Patent or Published Foreign Patent Application

Examiner Initial	No.	Document No.	Publication Date	Country or Patent Office	Class	Sub-class	Translation	
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Other Documents

Examiner Initial	No.	Author, Title, Date, Place (e.g. Journal) of Publication
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Examiner	<i>Shirley June S.</i>	Date Considered <i>6/20/02</i>

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